

# Product data sheet

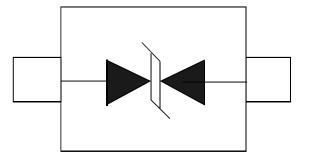
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Semiconductor Compiance

- 480Watts peak pulse power (tp =8/20µs)
- Bidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- IEC 61000-4-2 ±30kV contact ±30kVair
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 20A(8/20µs)





# »Applications

- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation
- Pagers Peripherals

#### **»Mechanical Data**

- SOD323 package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

### **Absolute Maximum Rating**

Rating	Symbol	Value	Units
Peak Pulse Power ( t <sub>p</sub> =8/20µs)	P <sub>PP</sub>	480	Watts
Peak Pulse Current ( t <sub>p</sub> =8/20µs ) (note1)	I <sub>pp</sub>	20	A
ESD per IEC 61000-4-2(Air) ESD per IEC 61000-4-2(Contact)	V <sub>ESD</sub>	30 30	kV
Lead Soldering Temperature	TL	260(10seconds)	°C
Junction Temperature	TJ	-55 to + 150	°C
Storage Temperature	T <sub>stg</sub>	-55 to + 150	°C



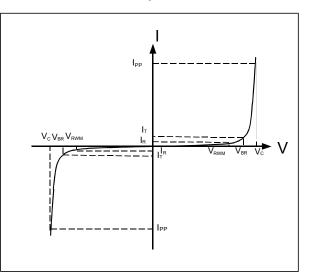


## **Electrical Characteristics**

Parameter	Symbol	Conditions	Min	Typical	Мах	Units
Reverse Stand-OffVoltage	V <sub>RWM</sub>				3.3	V
Reverse Breakdown Voltage	$V_{BR}$	I⊤=1mA	4.0			V
Reverse LeakageCurrent	I <sub>R</sub>	V <sub>RWM</sub> =3.0V,T=25℃			1	uA
Clamping Voltage	Vc	I <sub>PP</sub> =20A,t <sub>p</sub> =8/20µs			24	V
Junction Capacitance	Cj	$V_R$ = 0V, f =1MHz		100		pF

## **Electrical Parameters (TA = 25°C unless otherwisenoted)**

Symbol	Parameter	
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current	
Vc	Clamping Voltage @ IPP	
V <sub>RWM</sub>	Working Peak Reverse Voltage	
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>	
V <sub>BR</sub>	Breakdown Voltage @ I⊤	
IT	Test Current	

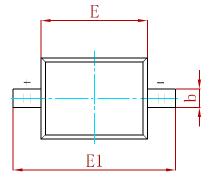


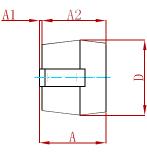
Note: 8/20µs pulsewaveform.

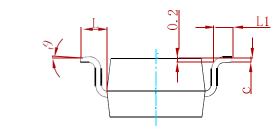




#### PACKAGE MECHANICAL DATA

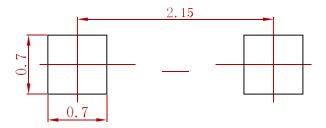






Cumhal	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
A		1.000		0.039
A1	0.000	0.100	0.000	0.004
A2	0.800	0.900	0.031	0.035
b	0.250	0.350	0.010	0.014
с	0.080	0.150	0.003	0.006
D	1.200	1.400	0.047	0.055
E	1.600	1.800	0.063	0.071
E1	2.550	2.750	0.100	0.108
L	0.475 REF.		0.019 REF.	
L1	0.250	0.400	0.010	0.016
θ	0°	8°	0°	8°

#### **Suggested Pad Layout**



#### Note:

1.Controlling dimension:in millimeters.

2.General tolerance:±0.05mm

3. The pad layout is for reference purposes only.

#### **REEL SPECIFICATION**

	P/N	PKG	QTY
F	PESD3V3L1BA-MS	SOD-323	3000



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